

Synbra Technology bv
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Onze ref.:

Doorkiesnr.:

Etten-Leur,

8-5-2014

WEEE Directive – Certificate of Compliance

Expanded Polystyrene Beads from:

Styrex® -grades

Styrex® HT-grades

SHOCK® -grades

Styrex® colour -Grades

Styrex® colour HT-grades

SHOCK® -colour grades

WEEE Directive (2002/96/EC)

The EU Directive 2002/96/EC ("WEEE directive") defines the recovery of waste electrical and electronic equipment. Therefore we as raw material supplier cannot provide a statement of compliance, because this is dependent on the final article.

F o r n o t i c e: Many substances are ubiquitous. The observance of all these substances is not part of Synbra Technology's ongoing production control.

In view of the many factors that may effect processing and application of our products, these data do not relieve processor from carrying out own investigations and tests neither do these data imply any guarantee for certain properties nor the suitability of the product for a specific purpose. It is the responsibility of the recipient of our products to ensure that any proprietary rights and existing laws and legislation are observed.

Signed on behalf of Synbra Technology bv,


J. Noordegraaf
Managing Director

The data indicated above are the results of our investigations and correspond to the state of the art. The data refer to the state of the laws at the date of issue.

This confirmation expires after 24 months or in case of regulatory changes.

Please ask for a new confirmation if needed.

It is the responsibility of those to whom we supply our products to ensure that any proprietary rights and existing laws and legislation are observed.

The certificate is exclusively for our customers and respective competent authorities. It is not intended for publication either printed or electronic form by others. Thus, neither partial nor full publication is allowed without written permission.